THE REAL PROPERTY OF THE PROPE

Docker No.: K-361

i	,	
As a below named inv	entor, I bereby declare that:	,
My residence, post off	ice and citizenship are as stated below next to my name,	'
names are listed be	inal, first and sole inventor (if only one name is listed below) or an origin low) of the subject matter claimed and for which a parent is TRANSPORT MODULE, the specification of which	
[X] is attached beret	amended on (if applicable)	asw bors
	have reviewed and understand the contents of the above identified spedment referred to above.	cification, including the claims, as
	ty to disclose information which is known to me to be material to patentations, Section 1.56(s).	ability in accordance with Title 37,
certificate, or 365(a) America, listed below	e priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign a of any PCT international application which designated at least one court and have also identified below, by checking the box, any foreign applicational application having a filing date before that of the application on whi	atry other than the United States of on for patent or inventor's contificate
Prior Foreign Applic <u>Number</u>		n Filing Date h/Dgy/Year
P2000-78487	KOREA Decemb	er 19, 2000
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I hereby claim the ber Application Number	efit under 35 U.S.C.119(e) of any United States provisional application(s)  [6]: Filing Date(Month/Day/Year)	listed below.
designating the United not disclosed in the principle. I acknowledge to	infit under 35, U. S. C. 120 of any United States application(s), or 365(c) d States of America, listed below and, insofar as the subject matter of earlier United States or PCT international application in the manner provided he duty to disclose information which is material to patentability as deffiling date of the prior application and the national or PCT international fi	ch of the claims of this application is I by the first paragraph of 35 U. S. C. Thed in 37 CFR 1.56 which became
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I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Rene A. Vasquez, Registration No. 38,647; Smart I. Smith, Registration No. 42,159; Carol L. Druzbick, Registration No. 40,287; Anthony H.Nourse, Registration No. 46,121; and Margaret A. Burke, Registration No. 34,474, all of

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with full power of substitution and revocation, to prosecute	e this application and to transact all business in the Patent and Trademark
Office connected therewith, and all future correspondence	should be addressed to them.
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